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Substitute for form 1449/PTO	Application Number
	Filing Date 09-17-2003 Cost Named Inventor SHI ET AL
INFORMATION DISCLOSURE	Pilst Mariou III
STATEMENT BY APPLICANT	Art Unit Examiner Name Thomas
(Use as many sheets as necessary)	Attorney Docket Number P120-US
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M	A1	US- 5,726,480	12/19/2000	TAI ET AL.	
$\overline{\perp}$	A2	US- 6,162,367	03/06/2001	TODA	
	A3	US- 6,355,181 B1	03/12/2002	MCQUARRIE	
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet	1	of	6
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Complete if Known			
Application Number	10/666,002		
Filing Date	9/17/03		
First Named Inventor	Shi		
Art Unit	Not Yel Assigned 4873		
Examiner Name	Not Yet Assigned Thomas		
Attorney Docket Number	P120-US		

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Examiner Initials	Cite No. 1 Number - Kind Code ² (If known	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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1	US- 4,310,380	12-12-1982	Flamm et al.	
	US- 4.498,953	02-12-1985	Cook et al.	
	US. 6.051,503	04-18-2000	Bhardwai, J.K.	
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1375	1	WO-98/32163	07-23-1998	Tai et al.		

Thomas Examiner Date Considered Signature

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of Sheet 2

Substitute for form 1449A/PTO

Complete if Known				
Application Number	10/666,002			
Filing Date	9/17/03			
First Named Inventor	Shi			
Art Unit	Not Yorkssigned 2873			
Examiner Name	Not Yet Asstaned Thomas			
Attorney Docket Number	P120-US			

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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of Sheet 3

Complete if Known				
Application Number	10/666,002			
Filing Date	9/17/03			
First Named Inventor	Shi			
Art Unit	Not Yet Assigned 2873			
Examiner Name	Not Yel Asstaned Thomas			
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			U.S. PATI	ENT DOCUMENTS	
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BNT		JP-1989/01208834-A	08-22-1989	Nobuo et al.		
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		JP-1992/04096222-A	03-27-1992	Atsuyuki, A.		_
BNI		JP-1995/07029823-A	01-31-1995	Hiroshi, T.		
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Complete if Known Substitute for form 1449B/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date First Named Inventor Shi STATEMENT BY APPLICANT Not Yet Assigned **Group Art Unit** Not Yet Assigned Examiner Name (use as many sheets as necessary) Attorney Docket Number P120-US of Sheet

		OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS	_
Examiner Initials	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), oublisher_city and/or country where published.	T
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		OTHER PRIOR ART NON PATENT LITERATURE DOCUMENTS	
Examiner Cite No. 1		Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	T ²
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Complete if Known Substitute for form 14498/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date Shi STATEMENT BY APPLICANT First Named Inventor Not Yet Assigned Group Art Unit Not Yet Assigned Examiner Name (use as many sheets as necessary) Attorney Docket Number P120-US of Sheet

		Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the	Т
Examiner Cite item (book, magazine, journal, serial, symposium, catalog, etc.), date, page initials No. 1 number(s) publisher city and/or country where published		item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	<u> </u>
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introl number.

Complete if Known Substitute for form 1449A/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date STATEMENT BY APPLICANT **First Named Inventor** Shi Art Unit Not Yet Assigned (use as many sheets as necessary) Not Yet Assigned nomas **Examiner Name** of 6 Attorney Docket Number P120-US Sheet

			U.S. PAT	ENT DOCUMENTS	
Examiner Initials		Document Number Number - Kind Code ² (if known	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
TUE		US- 3.511,727	05-12-1970	Hays, R.G.	
1		US- 4,190,488	02-26-1980	Winters, H.F.	
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	******	US- 2002/0033229 A1	03-21-2002	Lebouitz et al.	
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INFORMATION DISCLOSURE	Filing Date	9/17/03			
STATEMENT BY APPLICANT	First Named Inventor	Shi			
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Complete if Known Substitute for form 1449B/PTO 10/666,002 **Application Number** INFORMATION DISCLOSURE 9/17/03 Filing Date Shi First Named Inventor STATEMENT BY APPLICANT 2873 Homas Group Art Unit Not Yet Assigned Not Yet Assigned (use as many sheets as necessary) Examiner Name P120-US Attorney Docket Number Sheet of

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